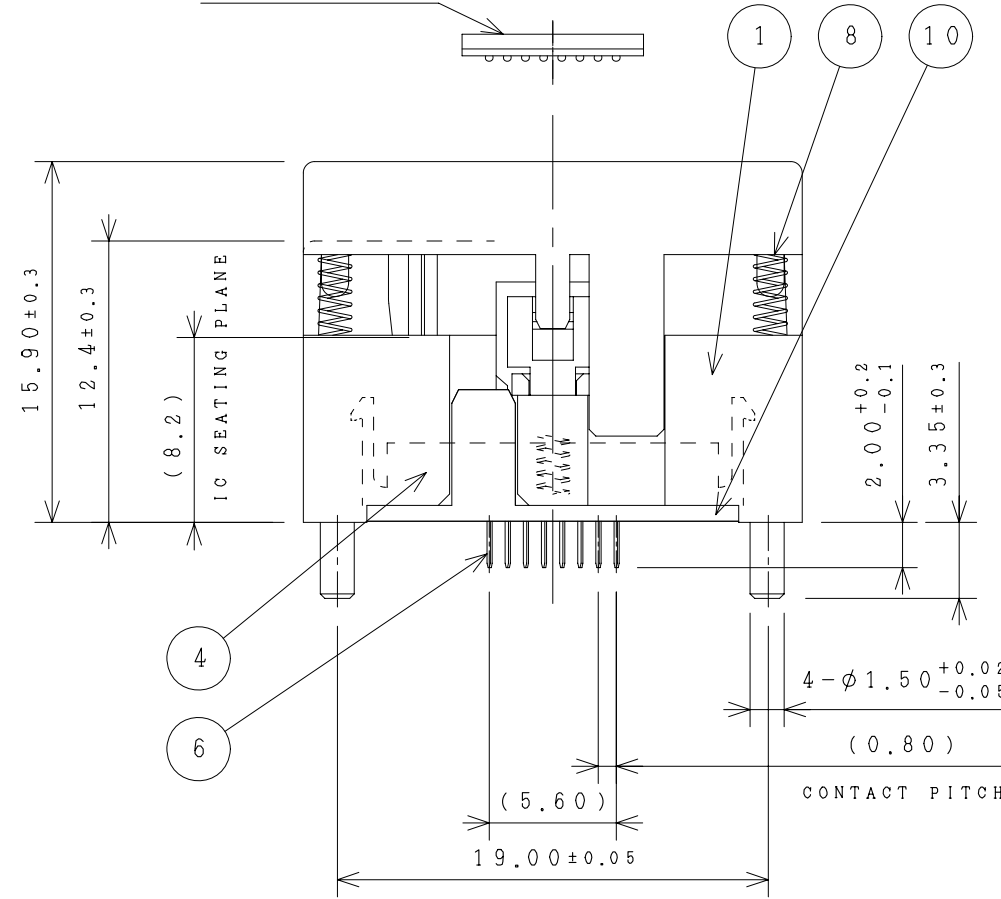
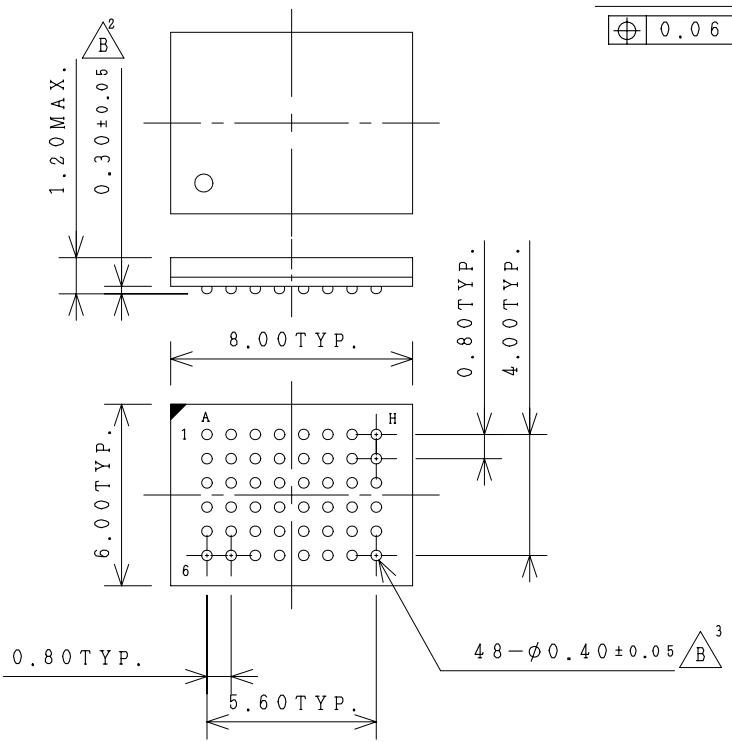
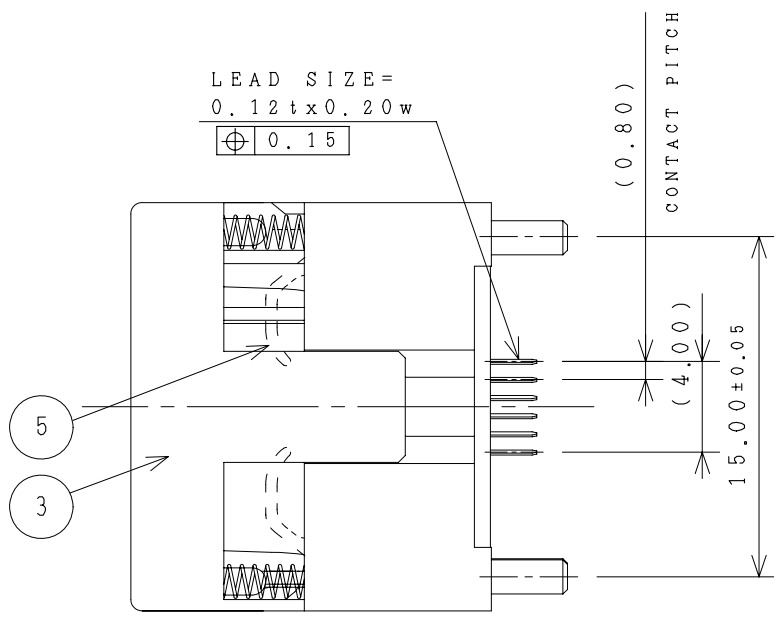


No. 1 PIN MARK

IC LOADING DIRECTION



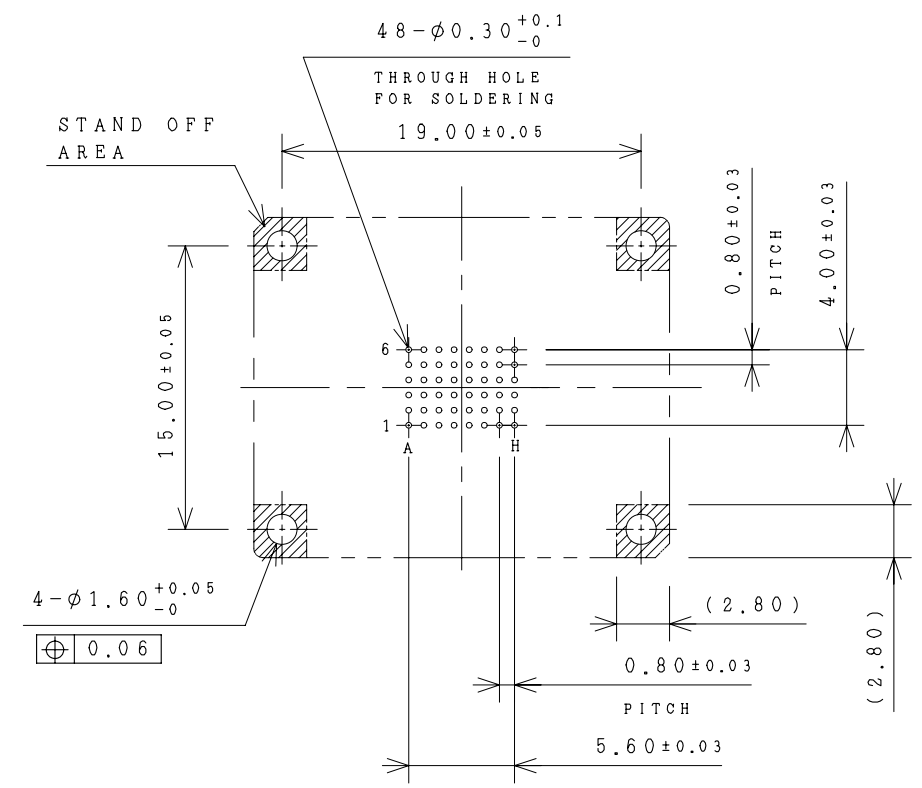
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FROM THE PROPRIETOR.



APPLICABLE IC DIMENSIONS

NO	PART DESC	MATERIAL	QTY	NOTE
10	LEAD GUIDE	PEI	1	BLACK
9	ADAPTER	PES	1	BLACK
8	SPRING	STAINLESS STEEL	4	FOR COVER
7	SPRING	STAINLESS STEEL	3	FOR SLIDER/LATCH
6	CONTACT	BELLYLIUM COPPER	48	GOLD PLATE
5	LATCH	PEI	2	BLACK
4	STOPPER	PEI	1	BLACK
3	COVER	PEI	1	BLACK
2	SLIDER	PEI	1	BLACK
1	BASE	PEI	1	BLACK

P. C. B. HOLE PATTERN (TOP VIEW)



REV.	DESCRIPTION	DRA.	DES.	CHE.	ENG.	APP.
X1	1: TI MARK IS REMOVED	JS LEE	JS LEE	DH CH	YJ PARK	HJ RA
	ECN0035533	05/10/07	05/10/07	05/10/07	05/10/07	05/10/07
	RELEASE THE DRAWING	HR. KWAK	HR. KWAK	HJ. RA	JS. SHIN	JS. SHIN
	ECN0016403	06/09/04	06/09/04	06/09/04	06/09/04	06/09/04
	1. ADAPTER SHAPE CHANGE 2-3: IC BALL DIMETER CHANGE	J1 CHO	J1 CHO	HJ RA		JS SHIN
	ECNP-137	10/30/02	10/30/02	11/13/02	/ /	11/14/02
	INITIAL RELEASE	KUCHINA	KUCHINA	YAMASHITA	NAKAMURA	HIBINO
	CR99105	03/19/99	03/19/99	/ /	03/19/99	03/19/99

SENSATA TECHNOLOGIES KOREA Ltd.
선사터 테크놀러지스
JINCHON PLANT

TITLE	CSP BURN IN TEST SOCKET	PART DESC.	48pin 0.8pitch 8.0x6.0
DRAWING NUMBER	CBG048-051E		SCALE
REV.	D	X	